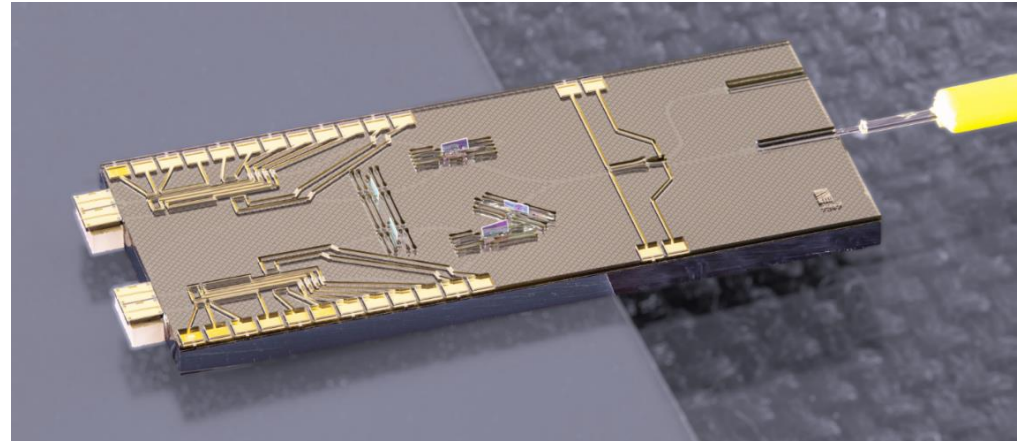

Hybrid Photonic Integration for Quantum Technologies

From optical benches to integrated circuits

Moritz Kleinert

Fraunhofer Heinrich Hertz Institute
Photonic Components Department



Photonic Integration

Monolithic and hybrid approaches

Monolithic Integration

Waveguides and actives on same die
→ Semiconductor material system

- + Optical sub-assembly = fabricated chip
- Limited by properties of material

Hybrid Integration

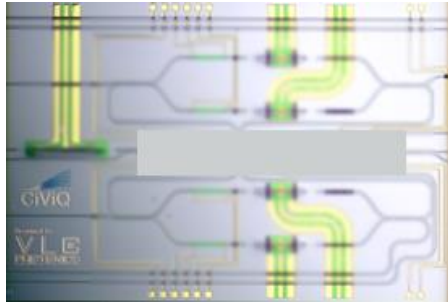
Waveguides and actives separate dies
→ actives: semiconductor
→ passives: Silica, Si_3N_4 , polymer
→ NLO: ppLN, ppKTP, ...

- Additional assembly necessary
- + Combination of optimal components and novel functionalities

Photonic Integration

Monolithic and hybrid approaches

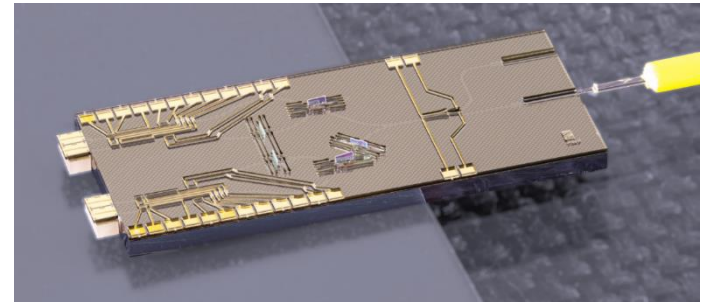
Monolithic Integration



CV-QKD-Tx
→ Monolithic InP PIC



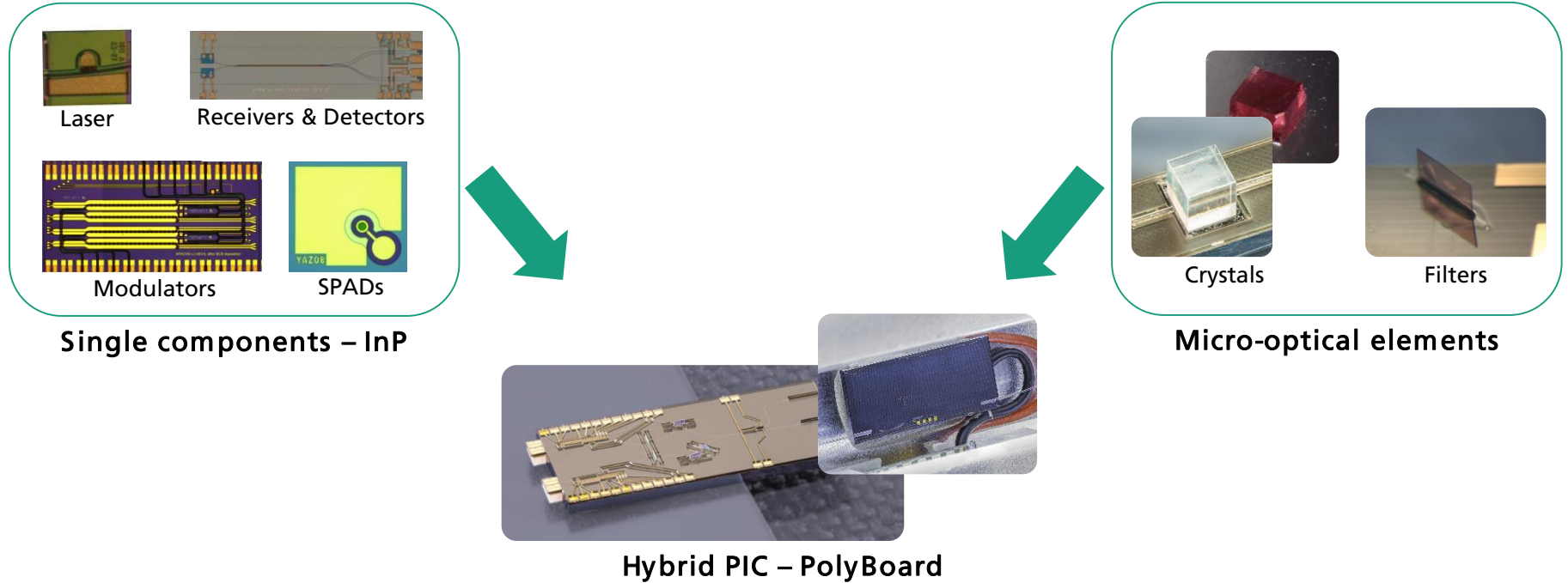
Hybrid Integration



DV-QKD-Tx
→ Hybrid InP + Polymer PIC



Hybrid Photonic Integration at HHI for quantum communications

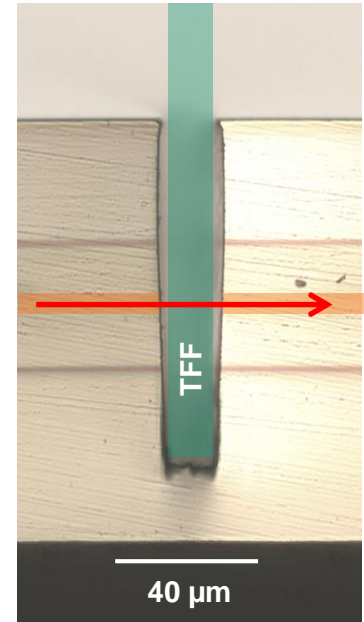
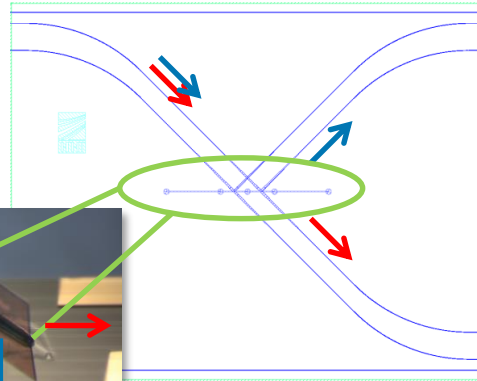
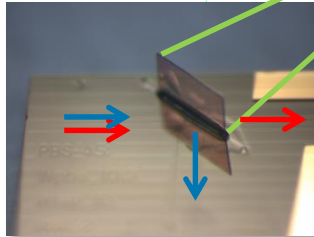
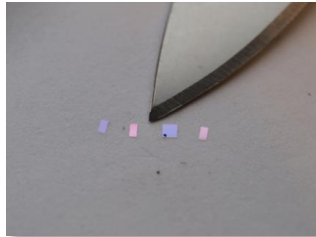
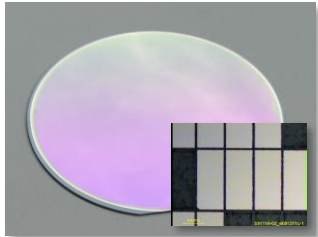


Slots & Thin Film Elements

Efficient on-chip filtering

Thin-film elements are based on dielectric layer stacks

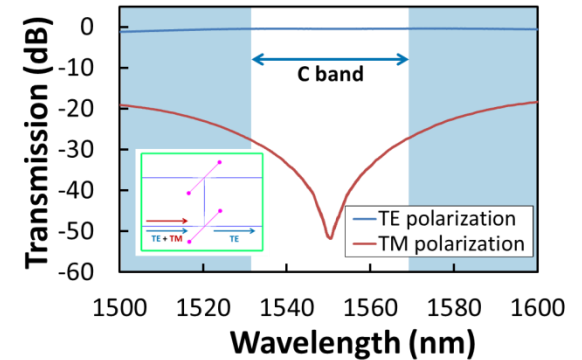
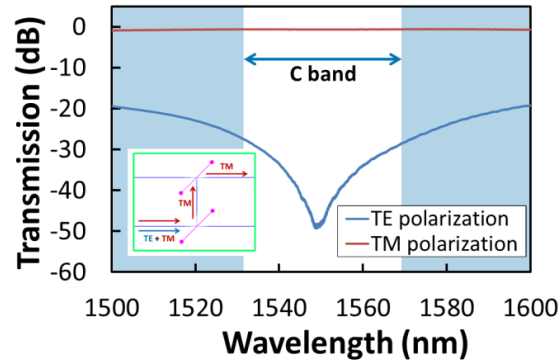
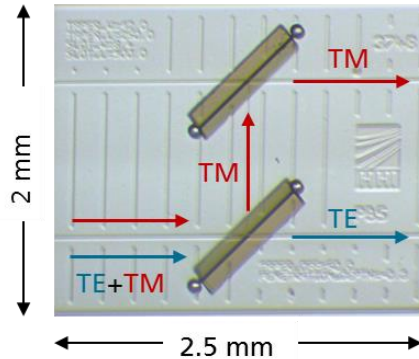
- Various efficient filter characteristics
→ wavelength, polarization etc.
- Small footprint
- Temperature-insensitive



Slots & Thin Film Elements

Example: Efficient polarization splitter

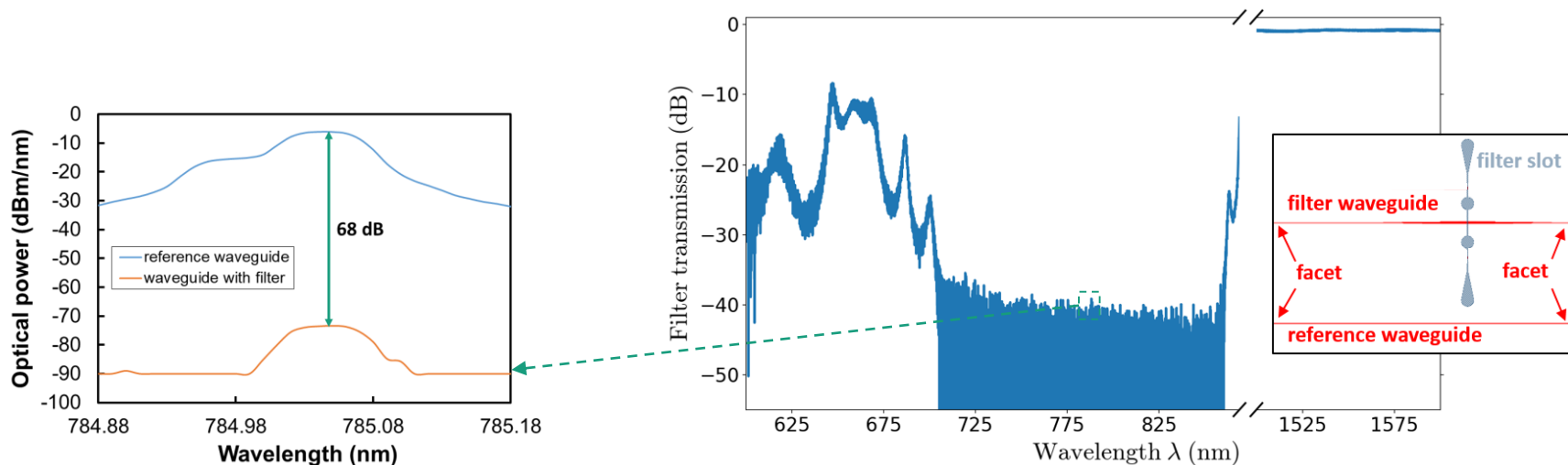
- Footprint: some mm²,
- Total insertion loss: <0.7 dB (fiber-chip-fiber)



Slots & Thin Film Elements

Example: Pump suppression filter

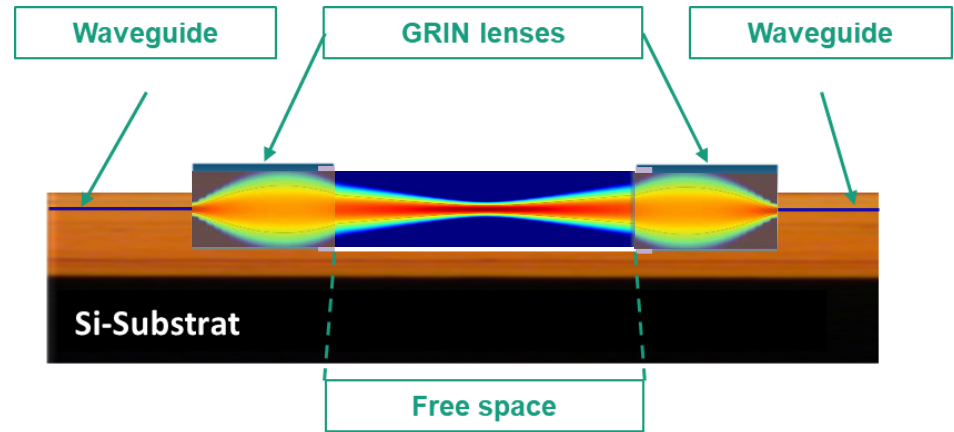
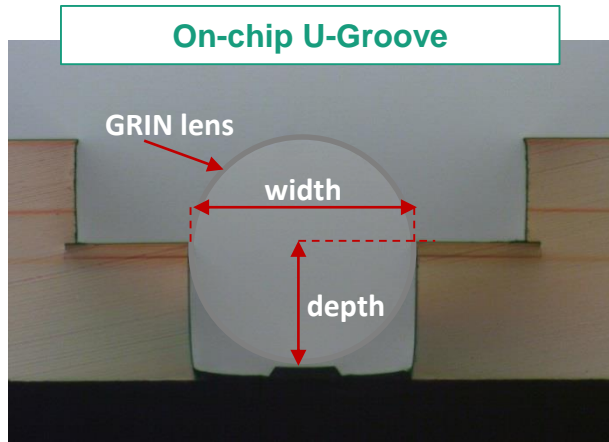
- Pass: C band / stop: around 785 nm
- 68 dB pump suppression on chip



Micro-Optical Bench

On-chip free-space sections

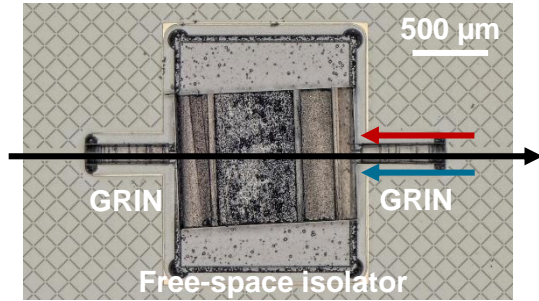
Beam collimation with GRIN lenses in on-chip U groove



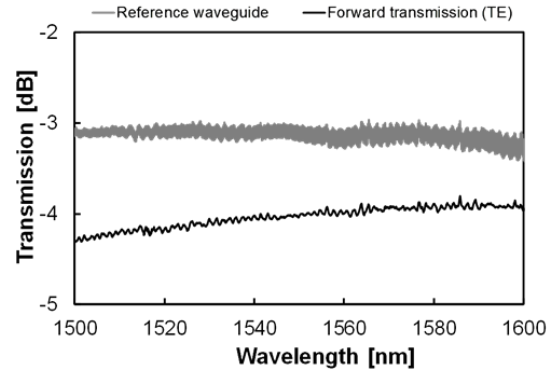
Free-space sections with lengths up to 10 mm
→ insertion of non-linear + non-reciprocal crystals

Micro-Optical Bench

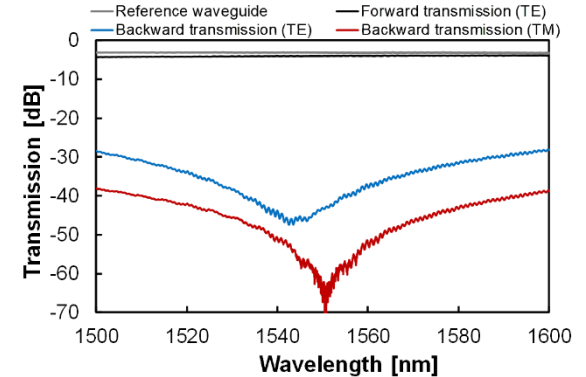
Example: Integrated optical free-space isolator



On-chip integrated free-space isolator



<1 dB on-chip loss in forward transmission

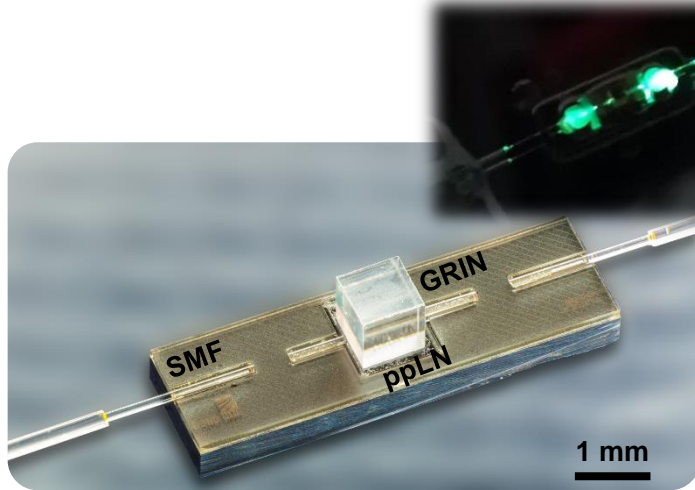


>40 dB peak isolation

<1 dB @1550 nm // > 28 dB isolation over 100 nm bandwidth

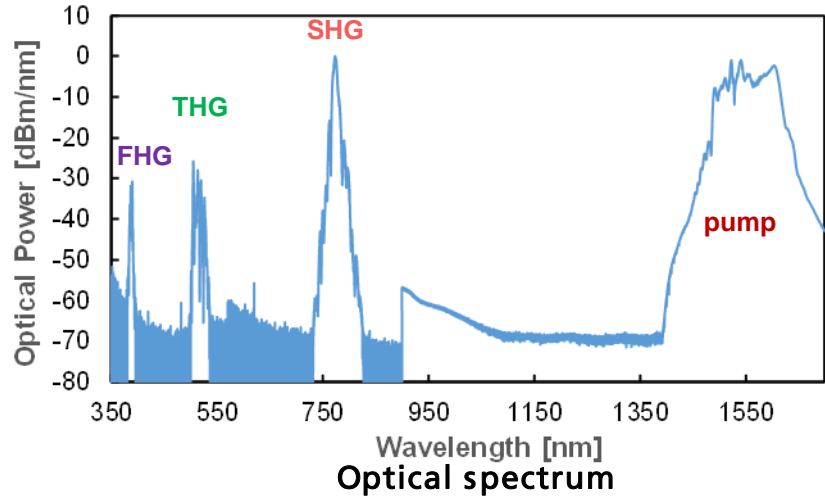
Micro-Optical Bench

Example: Non-linear optics with ppLN

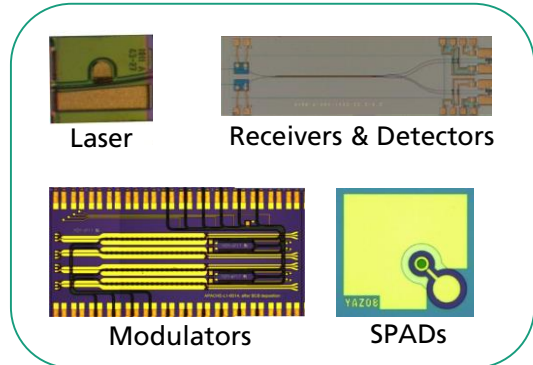


ppLN crystal in PolyBoard

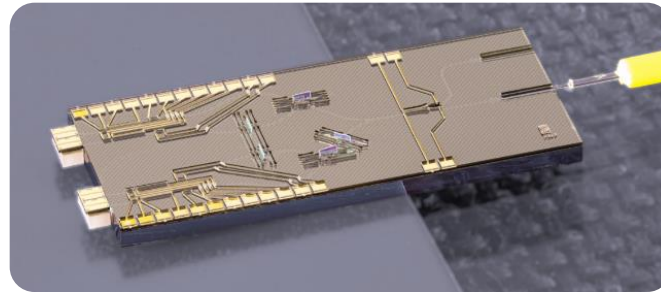
Higher harmonic generation
 $1550 \text{ nm} \rightarrow 775 \text{ nm} + 515 \text{ nm} + 387 \text{ nm}$



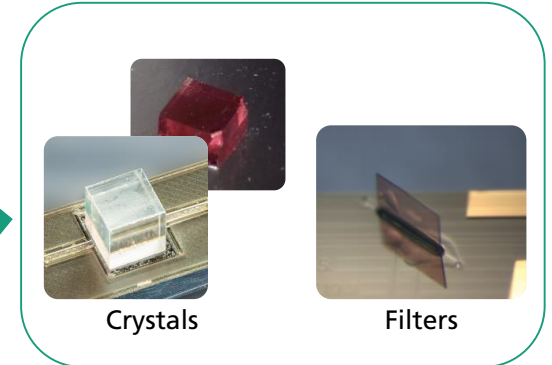
Hybrid Photonic Integration at HHI for quantum communications



Single components – InP



Hybrid PIC – PolyBoard

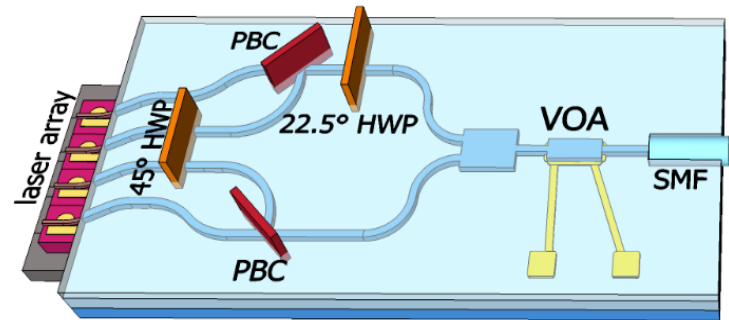
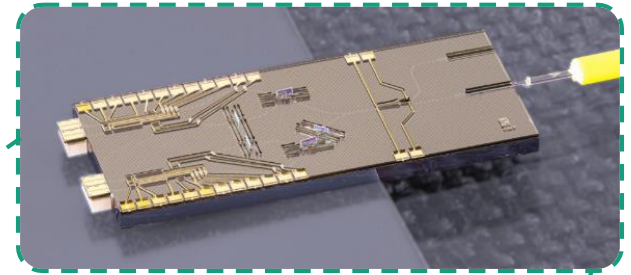


Micro-optical elements

Hybrid Photonic Integration

DV-QKD transmitter for polarization encoding

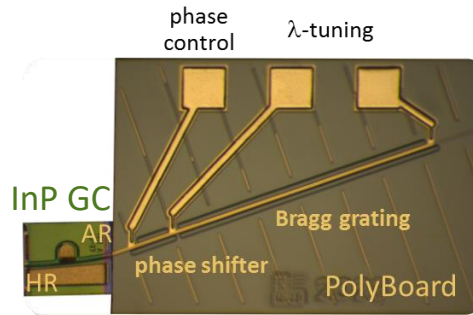
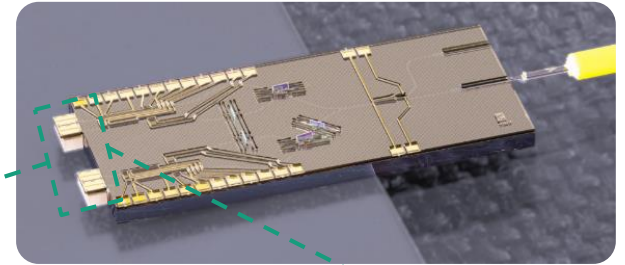
- Pulse sources
- Polarization handling
- Attenuation
- Optical isolation



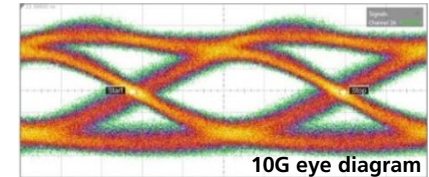
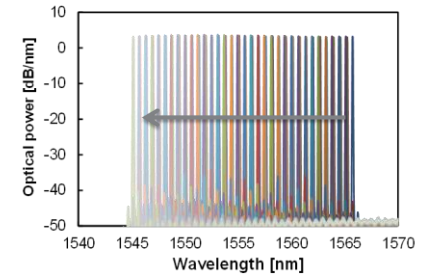
Hybrid Photonic Integration

DV-QKD transmitter for polarization encoding

- Pulse sources
→ Tunable laser
- Polarization handling
- Attenuation
- Optical isolation



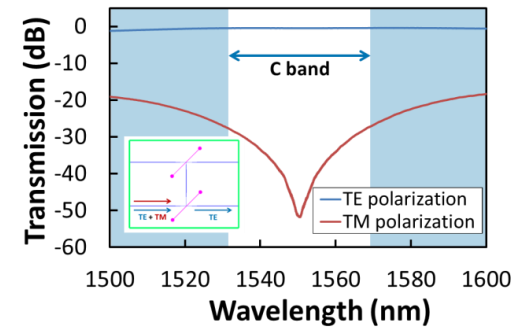
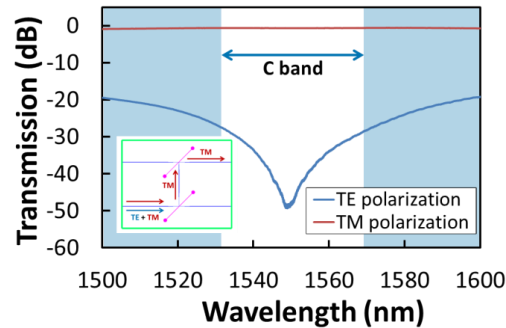
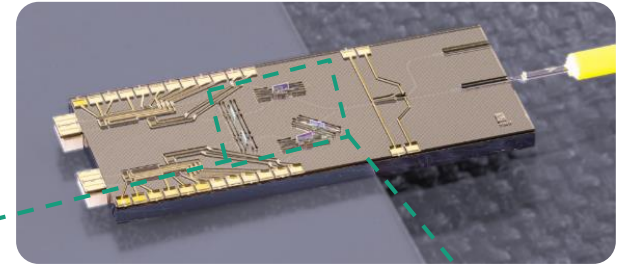
20 nm tuning range //
10 Gbit/s direct modulation



Hybrid Photonic Integration

DV-QKD transmitter for polarization encoding

- Pulse sources
→ Tunable laser
- Polarization handling
→ Thin-film filters
- Attenuation
- Optical isolation

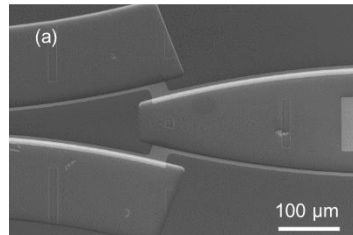
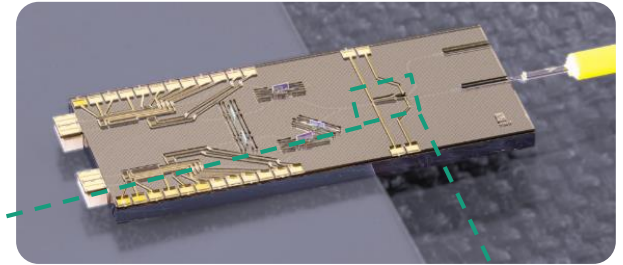


**> 45 dB max. polarization extinction ratio // > 25 dB PER
over C band // HWPs with >20 dB rotation efficiency**

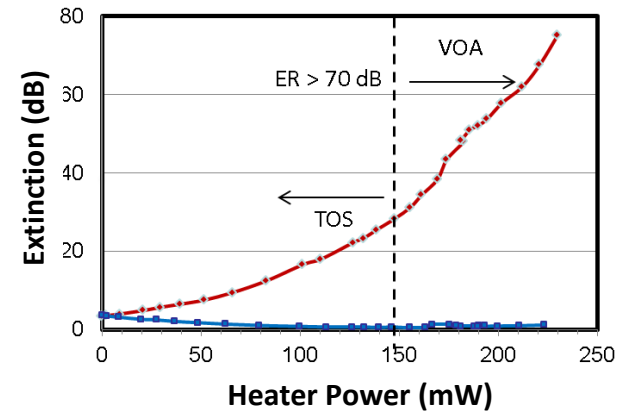
Hybrid Photonic Integration

DV-QKD transmitter for polarization encoding

- Pulse sources
→ Tunable laser
- Polarization handling
→ Thin-film filters
- Attenuation
→ Thermo-optic VOA
- Optical isolation



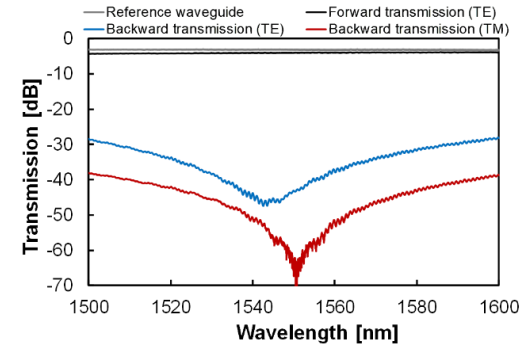
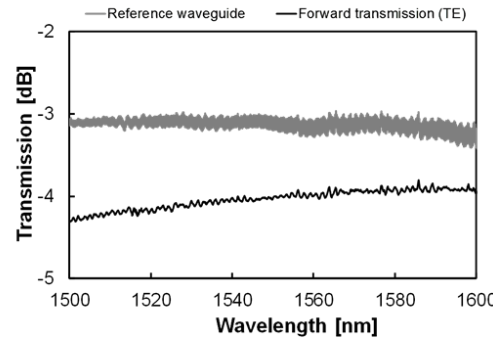
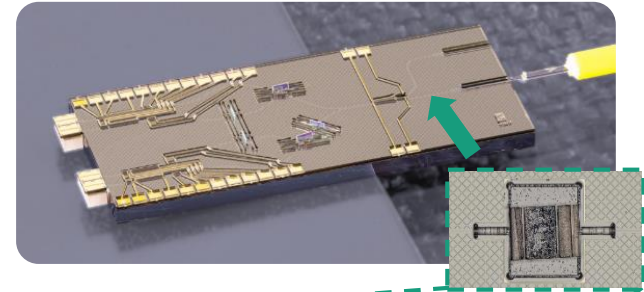
< 0.4 dB excess loss //
> 70 dB extinction ratio
→ Weak coherent pulses



Hybrid Photonic Integration

DV-QKD transmitter for polarization encoding

- Pulse sources
→ Tunable laser
- Polarization handling
→ Thin-film filters
- Attenuation
→ Thermo-optic VOA
- Optical isolation
→ Micro-optics



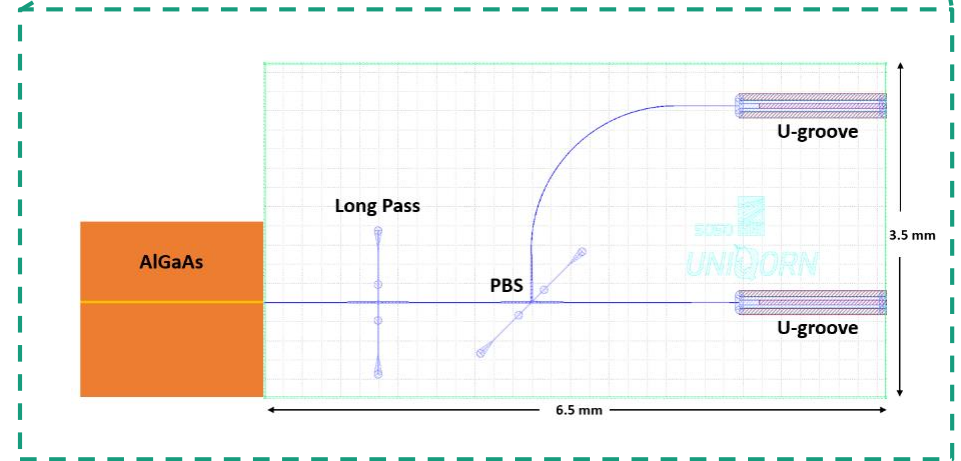
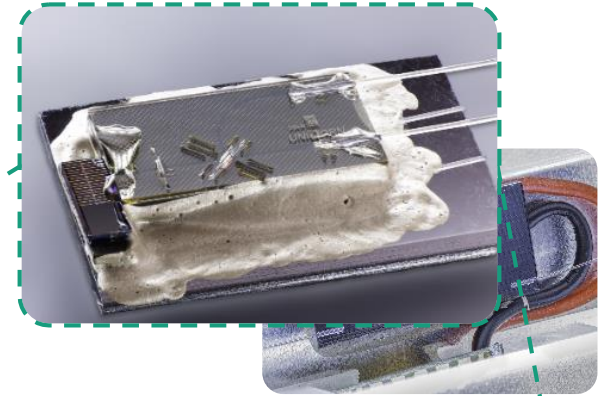
<1 dB on-chip loss // >28 dB isolation over 100 nm

Hybrid Photonic Integration

Time-bin entanglement source



- Photon pair generation
→ Bragg reflection waveguide
- Polarization handling
→ PBS thin film filter
- Pump suppression
- Delay line interferometer

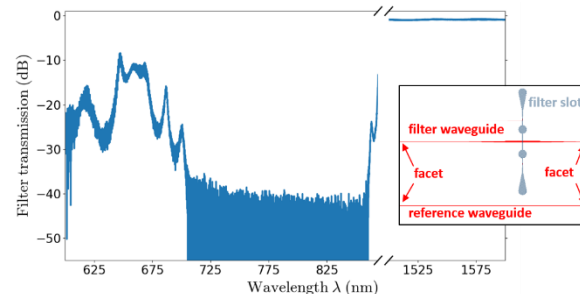
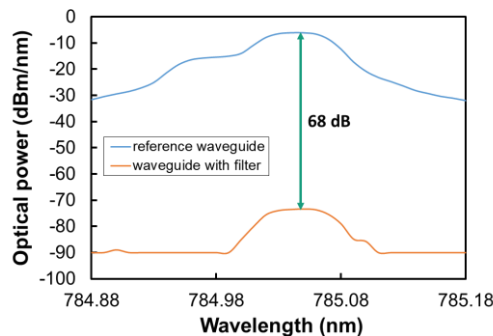
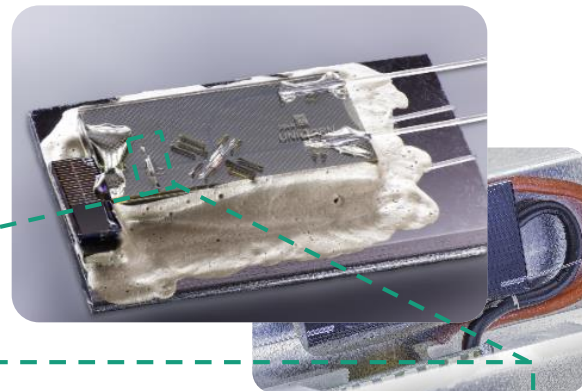


Hybrid Photonic Integration

Time-bin entanglement source



- Photon pair generation
→ Bragg reflection WG
- Polarization handling
→ PBS thin film filter
- Pump suppression
→ Thin-film filter
- Delay line interferometer



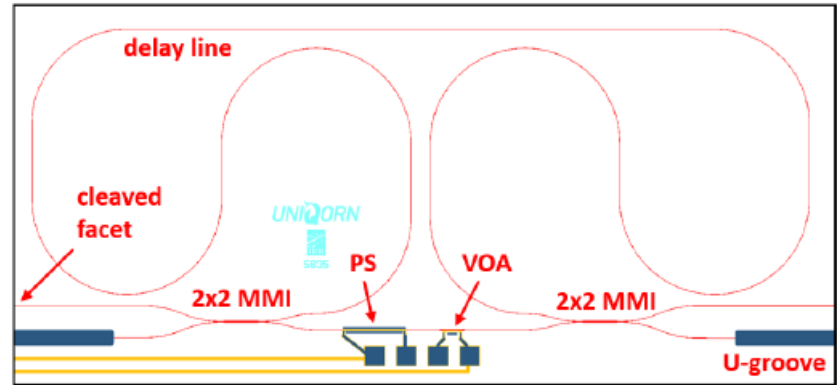
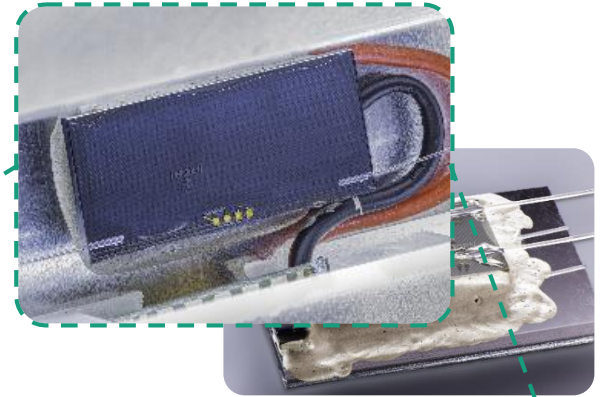
68 dB suppression of pump light @ 775 nm //
0.9 dB loss for signal/idler @ 1550 nm

Hybrid Photonic Integration

Time-bin entanglement source



- Photon pair generation
→ Bragg reflection WG
- Polarization handling
→ PBS thin film filter
- Pump suppression
→ Thin-film filter
- Delay line interferometer
→ Asymmetric MZI

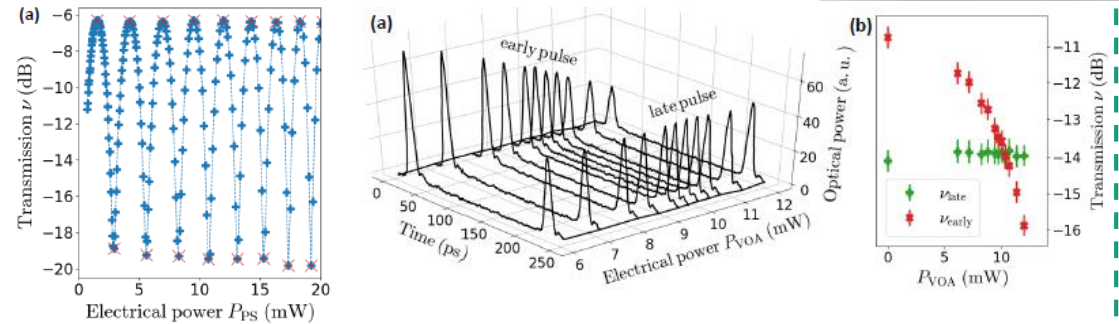


Hybrid Photonic Integration

Time-bin entanglement source



- Photon pair generation
→ Bragg reflection WG
- Polarization handling
→ PBS thin film filter
- Pump suppression
→ Thin-film filter
- Delay line interferometer
→ Asymmetric MZI

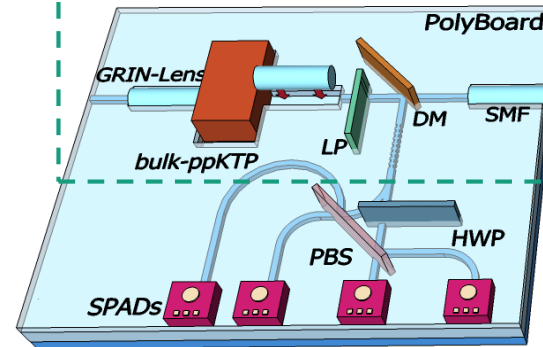
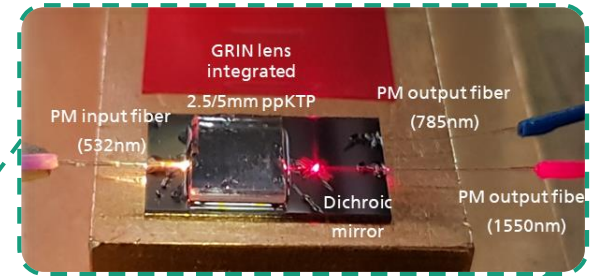


Tuning and stabilization with thermo-optic phase shifter and VOA

Hybrid Photonic Integration

Polarization entanglement source

- Pump suppression (532 nm)
→ Thin-film filter
- Signal/idler splitter (785 nm / 1550 nm)
→ Thin-film filter
- Photon pair generation



Fraunhofer Heinrich-Hertz-Institut, HHI

**WE PUT SCIENCE
INTO ACTION.**

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